

## C0805C241JDGACTU

Aliases (C0805C241JDGAC7800) SMD Comm COG HV, Ceramic, 240 pF, 5%, 1,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

240 pF

100 GOhms

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	1.25mm +/-0.15mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

-0.2mm	Measurement Condition	1 MHz 1.0Vrms
+/-0.2mm	Tolerance	5%
+/-0.15mm	Voltage DC	1000 VDC
MIN	Dielectric Withstanding Voltage	1,200 VDC
+/-0.25mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
Omm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour

**Specifications** 

Insulation Resistance

Capacitance

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

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